

# N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup> 25 V, 130 A, 1.2 m $\Omega$

#### Features

- Max  $r_{DS(on)}$  = 1.2 m $\Omega$  at  $V_{GS}$  = 10 V,  $I_D$  = 35 A
- Max  $r_{DS(on)}$  = 1.65 m $\Omega$  at  $V_{GS}$  = 4.5 V,  $I_D$  = 31 A
- Advanced Package and Silicon combination for low r<sub>DS(on)</sub> and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

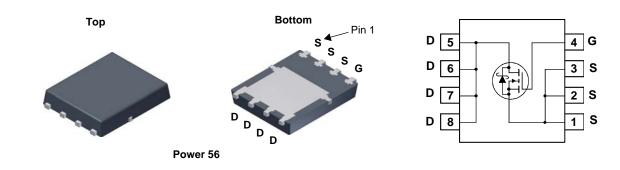


## **General Description**

The FDMS7556S has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest  $r_{DS(on)}$  while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

## Applications

- Synchronous Rectifier for Synchronous Buck Converters
- Notebook
- Server
- Telecom
- High Efficiency DC-DC Switch Mode Power Supplies



### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

| Symbol                            | Parameter                                    |                        |           | Ratings     | Units |  |
|-----------------------------------|--|------------------------|-----------|-------------|-------|--|
| V <sub>DS</sub>                   | Drain to Source Voltage                      |                        |           | 25          | V     |  |
| V <sub>GS</sub>                   | Gate to Source Voltage                       |                        | (Note 4)  | ±20         | V     |  |
|                                   | Drain Current -Continuous (Package limited)  | T <sub>C</sub> = 25 °C |           | 130         |       |  |
| ,                                 | -Continuous (Silicon limited)                | T <sub>C</sub> = 25 °C |           | 222         | ^     |  |
| D                                 | -Continuous                                  | T <sub>A</sub> = 25 °C | (Note 1a) | 35          | Α     |  |
|                                   | -Pulsed                                      |                        |           | 200         |       |  |
| E <sub>AS</sub>                   | Single Pulse Avalanche Energy                |                        | (Note 3)  | 312         | mJ    |  |
| D                                 | Power Dissipation                            | T <sub>C</sub> = 25 °C |           | 96          | w     |  |
| P <sub>D</sub>                    | Power Dissipation                            | T <sub>A</sub> = 25 °C | (Note 1a) | 2.5         | vv    |  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Junction Temperature R | ange                   |           | -55 to +150 | °C    |  |

| $R_{\thetaJC}$ | Thermal Resistance, Junction to Case              | 1.3 | °C/W |  |
|----------------|---|-----|------|--|
| $R_{\thetaJA}$ | Thermal Resistance, Junction to Ambient (Note 1a) | 50  | C/VV |  |

#### Package Marking and Ordering Information

| Device Marking | Device    | Package  | Reel Size | Tape Width | Quantity   |
|----------------|-----------|----------|-----------|------------|------------|
| FDMS7556S      | FDMS7556S | Power 56 | 13 "      | 12 mm      | 3000 units |

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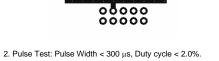
| FDMS7556S                            |
|--------------------------------------|
| N-Channel                            |
| Power Trenc                          |
| ch <sup>®</sup> SyncFET <sup>T</sup> |
| Ξ                                    |

|   | Parameter   | Test Conditions   | Min | Тур   | Max  | Units   |
|---|---|---|-----|---|--|---|
| Off Chara   | cteristics  |   |     |   |  |   |
| BV <sub>DSS</sub>   | Drain to Source Breakdown Voltage   | I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0 V  | 25  |   |  | V   |
| $\frac{\Delta BV_{DSS}}{\Delta T_J}$  | Breakdown Voltage Temperature<br>Coefficient  | $I_D = 10$ mA, referenced to 25 °C  |     | 22  |  | mV/°C   |
| IDSS  | Zero Gate Voltage Drain Current   | $V_{DS} = 20 V, V_{GS} = 0 V$   |     |   | 500  | μΑ  |
| GSS   | Gate to Source Leakage Current, Forward   | $V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$   |     |   | 100  | nA  |
| On Chara  | cteristics  |   |     |   |  |   |
| V <sub>GS(th)</sub>   | Gate to Source Threshold Voltage  | $V_{GS} = V_{DS}$ , $I_D = 1 \text{ mA}$  | 1.2 | 1.6   | 3.0  | V   |
| $\frac{\Delta V_{GS(th)}}{\Delta T_{.l}}$   | Gate to Source Threshold Voltage<br>Temperature Coefficient   | $I_D = 10$ mA, referenced to 25 °C  |     | -5  |  | mV/°C   |
|   |   | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 35 A   |     | 0.95  | 1.2  |   |
| r <sub>DS(on)</sub>   | Static Drain to Source On Resistance  | $V_{GS} = 4.5 \text{ V}, I_D = 31 \text{ A}$  |     | 1.3   | 1.65   | mΩ  |
| - ( - )   |   | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 35 A, T <sub>J</sub> = 125 °C  |     | 1.2   | 1.6  |   |
| 9fs   | Forward Transconductance  | V <sub>DS</sub> = 5 V, I <sub>D</sub> = 35 A  |     | 212   |  | S   |
| C <sub>iss</sub>  | Input Capacitance   | V <sub>DS</sub> = 13 V, V <sub>GS</sub> = 0 V,  |     | 6740  | 8965   | рF  |
|   |   |   |     | 1010  | 2500   | ~ -   |
| C <sub>oss</sub>  | Output Capacitance  | _f = 1 MHz  |     | 1940  | 2580   | pF  |
|   | Output Capacitance           Reverse Transfer Capacitance           Gate Resistance   |   |     | 314<br>0.6  | 475<br>1.3   | ρF<br>pF<br>Ω                                     |
| C <sub>oss</sub><br>C <sub>rss</sub><br>R <sub>g</sub><br>Switchinç   | Reverse Transfer Capacitance<br>Gate Resistance<br>Characteristics  |   |     | 314   | 475  | pF  |
| C <sub>oss</sub><br>C <sub>rss</sub><br>R <sub>g</sub><br>Switching   | Reverse Transfer Capacitance<br>Gate Resistance   | - f = 1 MHz   |     | 314<br>0.6  | 475<br>1.3   | pF<br>Ω   |
| C <sub>oss</sub><br>C <sub>rss</sub><br>Rg<br>Switching<br>t <sub>d(on)</sub>   | Reverse Transfer Capacitance         Gate Resistance <b>Characteristics</b> Turn-On Delay Time  |   |     | 314<br>0.6<br>20  | 475<br>1.3<br>36                                       | pF<br>Ω<br>ns                                     |
| C <sub>oss</sub><br>C <sub>rss</sub><br>Rg<br><b>Switching</b><br>t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub>   | Reverse Transfer Capacitance         Gate Resistance <b>Characteristics</b> Turn-On Delay Time         Rise Time  | f = 1 MHz<br>V <sub>DD</sub> = 13 V, I <sub>D</sub> = 35 A,   |     | 314<br>0.6<br>20<br>9   | 475<br>1.3<br>36<br>18                                 | pF<br>Ω<br>ns                                     |
| C <sub>oss</sub><br>C <sub>rss</sub><br>Rg<br><b>Switching</b><br>t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub>   | Reverse Transfer Capacitance         Gate Resistance <b>Characteristics</b> Turn-On Delay Time         Rise Time         Turn-Off Delay Time  | f = 1 MHz<br>V <sub>DD</sub> = 13 V, I <sub>D</sub> = 35 A,   |     | 314<br>0.6<br>20<br>9<br>48                                   | 475<br>1.3<br>36<br>18<br>77                           | pF<br>Ω<br>ns<br>ns<br>ns                         |
| C <sub>oss</sub><br>C <sub>rss</sub><br><b>R</b> g<br><b>Switching</b><br>t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Q <sub>g</sub>   | Reverse Transfer Capacitance         Gate Resistance <b>Characteristics</b> Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time  | $f = 1 \text{ MHz}$ $V_{DD} = 13 \text{ V}, I_D = 35 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 13 \text{ V}$ |     | 314<br>0.6<br>20<br>9<br>48<br>5.3                            | 475<br>1.3<br>36<br>18<br>77<br>11                     | pF<br>Ω<br>ns<br>ns<br>ns<br>ns                   |
| C <sub>oss</sub><br>C <sub>rss</sub><br><b>R</b> g<br><b>Switching</b><br>t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Q <sub>g</sub><br>Q <sub>g</sub>   | Reverse Transfer Capacitance         Gate Resistance <b>Characteristics</b> Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge  | f = 1  MHz<br>V <sub>DD</sub> = 13 V, I <sub>D</sub> = 35 A,<br>V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω  |     | 314<br>0.6<br>20<br>9<br>48<br>5.3<br>95                      | 475<br>1.3<br>36<br>18<br>77<br>11<br>133              | pF<br>Ω<br>ns<br>ns<br>ns<br>ns<br>nC             |
| C <sub>oss</sub><br>C <sub>rss</sub><br><b>R</b> g<br><b>Switching</b><br>t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Q <sub>g</sub><br>Q <sub>gs</sub>  | Reverse Transfer Capacitance         Gate Resistance <b>Characteristics</b> Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge  | $f = 1 \text{ MHz}$ $V_{DD} = 13 \text{ V}, I_D = 35 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 13 \text{ V}$ |     | 314<br>0.6<br>20<br>9<br>48<br>5.3<br>95<br>43                | 475<br>1.3<br>36<br>18<br>77<br>11<br>133              | pF<br>Ω<br>ns<br>ns<br>ns<br>nC<br>nC             |
| C <sub>oss</sub><br>C <sub>rss</sub><br>R <sub>g</sub><br>Switching<br>t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Q <sub>g</sub><br>Q <sub>g</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub>              | Reverse Transfer Capacitance         Gate Resistance <b>Characteristics</b> Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Gate Charge                                       | $f = 1 \text{ MHz}$ $V_{DD} = 13 \text{ V}, I_D = 35 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 13 \text{ V}$ |     | 314<br>0.6<br>20<br>9<br>48<br>5.3<br>95<br>43<br>18.6        | 475<br>1.3<br>36<br>18<br>77<br>11<br>133              | pF<br>Ω<br>ns<br>ns<br>ns<br>nC<br>nC<br>nC       |
| C <sub>oss</sub><br>C <sub>rss</sub><br>R <sub>g</sub><br>Switching<br>t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Q <sub>g</sub><br>Q <sub>g</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub><br>Drain-Sou | Reverse Transfer Capacitance         Gate Resistance <b>Characteristics</b> Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Gate Charge         Gate to Drain "Miller" Charge |   |     | 314<br>0.6<br>20<br>9<br>48<br>5.3<br>95<br>43<br>18.6        | 475<br>1.3<br>36<br>18<br>77<br>11<br>133              | pF<br>Ω<br>ns<br>ns<br>ns<br>nC<br>nC<br>nC<br>nC |
| C <sub>oss</sub><br>C <sub>rss</sub><br>R <sub>g</sub><br>Switching<br>t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Q <sub>g</sub><br>Q <sub>g</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub>              | Reverse Transfer Capacitance         Gate Resistance <b>Characteristics</b> Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Gate Charge         Gate to Drain "Miller" Charge | $f = 1 \text{ MHz}$ $V_{DD} = 13 \text{ V}, I_D = 35 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{DD} = 13 \text{ V}$ $I_D = 35 \text{ A}$                     |     | 314<br>0.6<br>20<br>9<br>48<br>5.3<br>95<br>43<br>18.6<br>8.8 | 475<br>1.3<br>36<br>18<br>77<br>11<br>133<br>60        | pF<br>Ω<br>ns<br>ns<br>ns<br>nC<br>nC<br>nC       |
| C <sub>oss</sub><br>C <sub>rss</sub><br>R <sub>g</sub><br>Switching<br>t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Q <sub>g</sub><br>Q <sub>g</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub><br>Drain-Sou | Reverse Transfer Capacitance         Gate Resistance <b>Characteristics</b> Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Gate Charge         Gate to Drain "Miller" Charge |   |     | 314<br>0.6<br>20<br>9<br>48<br>5.3<br>95<br>43<br>18.6<br>8.8 | 475<br>1.3<br>36<br>18<br>77<br>11<br>133<br>60<br>0.7 | pF<br>Ω<br>ns<br>ns<br>ns<br>nC<br>nC<br>nC<br>nC |

1 in<sup>2</sup> pad of 2 oz copper.



b. 125 °C/W when mounted on a minimum pad of 2 oz copper.



3.  $E_{AS}$  of 312 mJ is based on starting  $T_J$  = 25 °C, L = 1 mH,  $I_{AS}$  = 25 A,  $V_{DD}$  = 23 V,  $V_{GS}$  = 10 V. 100% test at L = 0.3 mH,  $I_{AS}$  = 38 A.

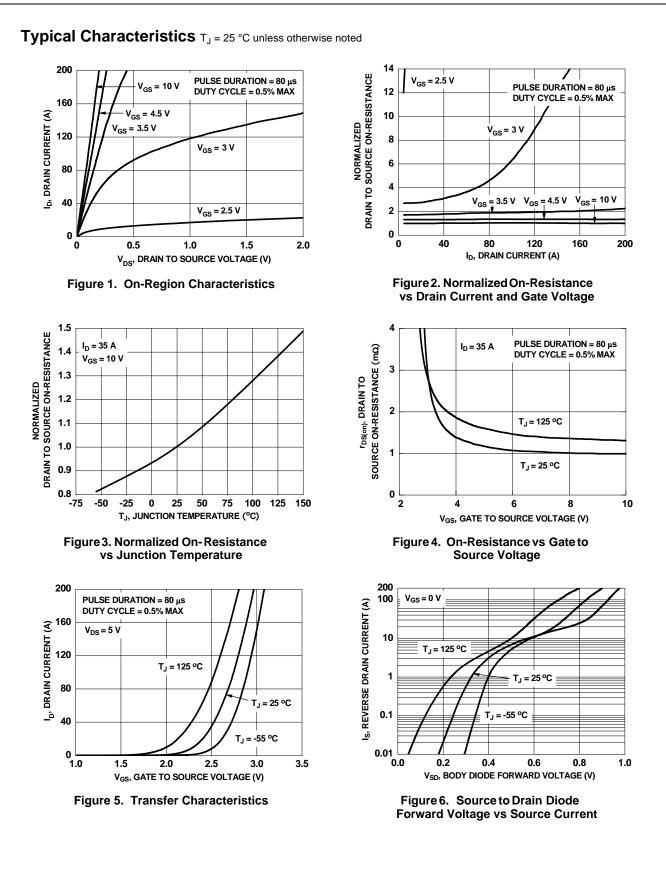
4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

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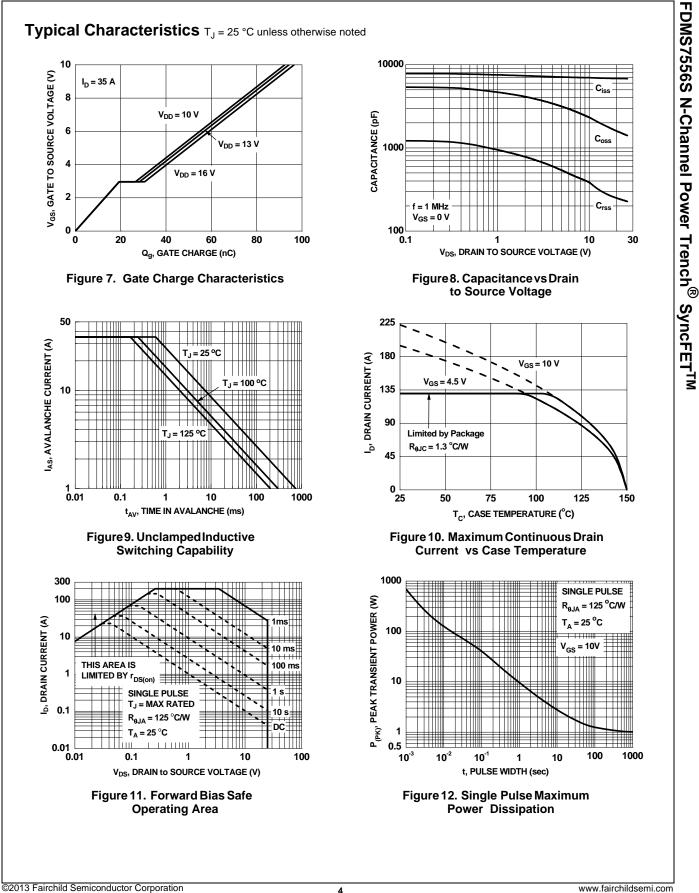
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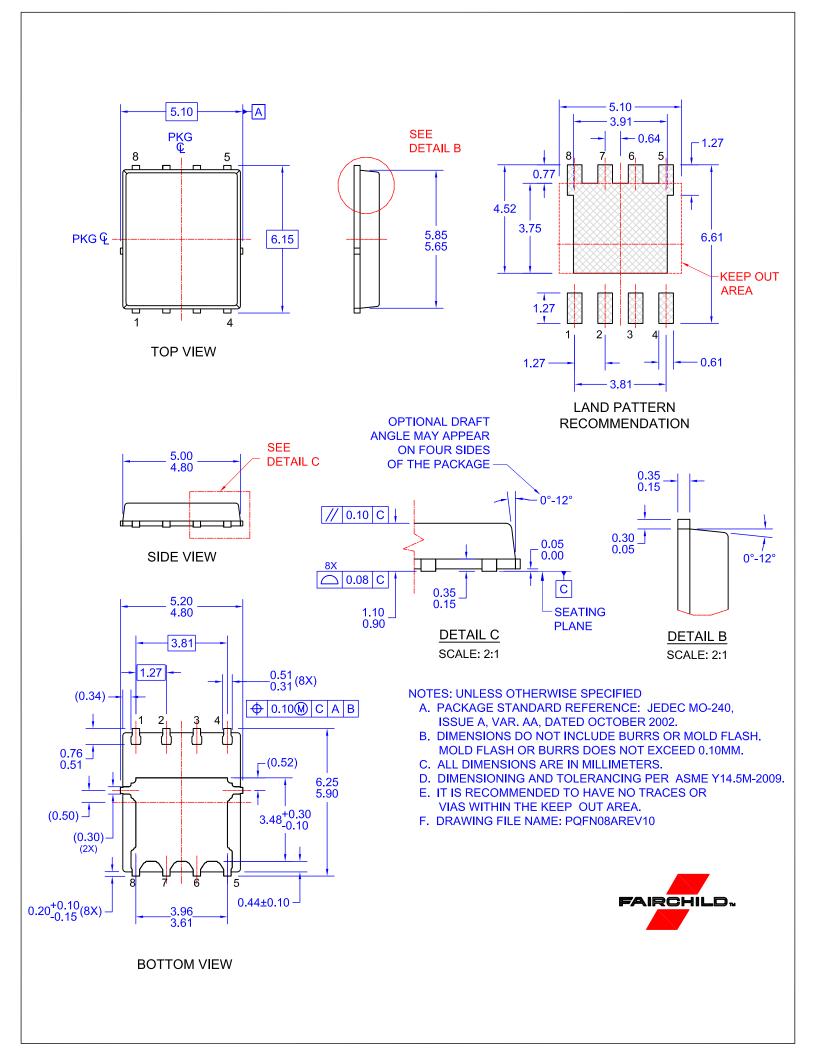
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FDMS7556S Rev.C4



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